



BCX55-Q series

60 V, 1 A NPN medium power transistors

Rev. 1 — 14 July 2022

Product data sheet

1. General description

NPN medium power transistors in a SOT89 (SC-62) flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

| Type number | Package | | NPN complement |
|-------------|----------|-------|----------------|
| | Nexperia | JEITA | |
| BCX55-Q | SOT89 | SC-62 | BCX52-Q |
| BCX55-10-Q | | | BCX52-10-Q |
| BCX55-16-Q | | | BCX52-16-Q |

2. Features and benefits

- High current
- Three current gain selections
- High power dissipation capability
- Exposed heatsink for excellent thermal and electrical conductivity
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Linear voltage regulators
- Power management
- Low-side switches
- MOSFET drivers
- Battery-driven devices
- Amplifiers

4. Quick reference data

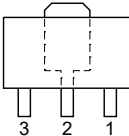
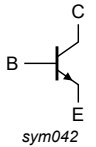
Table 2. Quick reference data

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|-----------|---------------------------|---|-----|-----|-----|------|--|
| V_{CEO} | collector-emitter voltage | open base | - | - | 60 | V | |
| I_C | collector current | | - | - | 1 | A | |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1$ ms | - | - | 2 | A | |
| h_{FE} | DC current gain | | | | | | |
| | BCX55-Q | $V_{CE} = 2$ V; $I_C = 150$ mA; $T_{amb} = 25$ °C | [1] | 63 | - | 250 | |
| | BCX55-10-Q | | [1] | 63 | - | 160 | |
| | BCX55-16-Q | | [1] | 100 | - | 250 | |

[1] pulsed; $t_p \leq 300$ μ s; $\delta \leq 0.02$

5. Pinning information

Table 3. Pinning

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------|--|---|
| 1 | E | emitter |  |  |
| 2 | C | collector | | |
| 3 | B | base | | |

6. Ordering information

Table 4. Ordering information

| Type number | Package | | Version |
|-------------|---------|--|---------|
| | Name | Description | |
| BCX55-Q | SC-62 | plastic surface-mounted package; exposed die pad for good heat transfer; 3 leads | SOT89 |
| BCX55-10-Q | | | |
| BCX55-16-Q | | | |

7. Marking

Table 5. Marking

| Type number | Marking code |
|-------------|--------------|
| BCX55-Q | BE |
| BCX55-10-Q | BG |
| BCX55-16-Q | BM |

8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|---------------------------|-------------------------------|-----|------|------|
| V_{CBO} | collector-base voltage | open emitter | - | 60 | V |
| V_{CEO} | collector-emitter voltage | open base | - | 60 | V |
| V_{EBO} | emitter-base voltage | open collector | - | 5 | V |
| I_C | collector current | | - | 1 | A |
| I_{CM} | peak collector current | single pulse; $t_p \leq 1$ ms | - | 2 | A |
| I_B | base current | | - | 0.3 | A |
| I_{BM} | peak base current | single pulse; $t_p \leq 1$ ms | - | 0.3 | A |
| P_{tot} | total power dissipation | $T_{amb} \leq 25$ °C [1] | - | 0.50 | W |
| | | [2] | - | 0.95 | W |
| | | [3] | - | 1.35 | W |
| T_j | junction temperature | | - | 150 | °C |
| T_{amb} | ambient temperature | | -55 | 150 | °C |
| T_{stg} | storage temperature | | -65 | 150 | °C |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm².
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm².

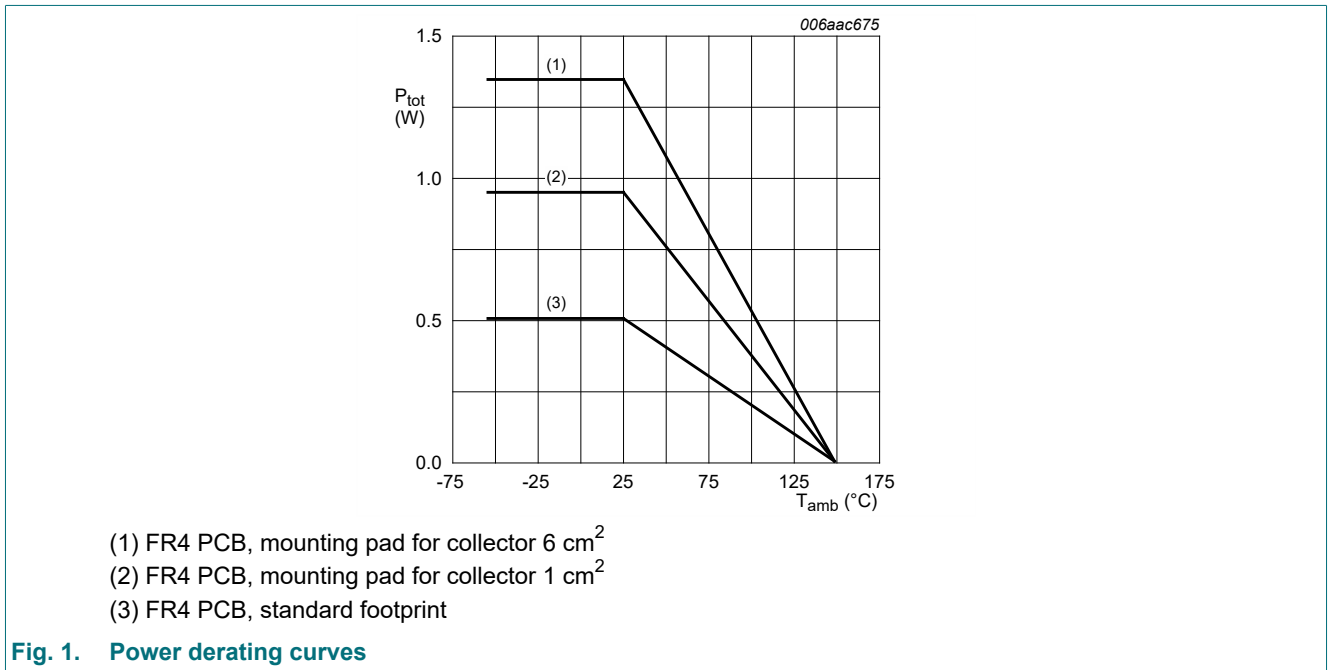


Fig. 1. Power derating curves

9. Thermal characteristics

Table 7. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|----------------|--|-------------|-----|-----|-----|------|-----|
| $R_{th(j-a)}$ | thermal resistance from junction to ambient | in free air | [1] | - | - | 250 | K/W |
| | | | [2] | - | - | 132 | K/W |
| | | | [3] | - | - | 93 | K/W |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point | | - | - | 16 | K/W | |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm².

[3] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 6 cm².

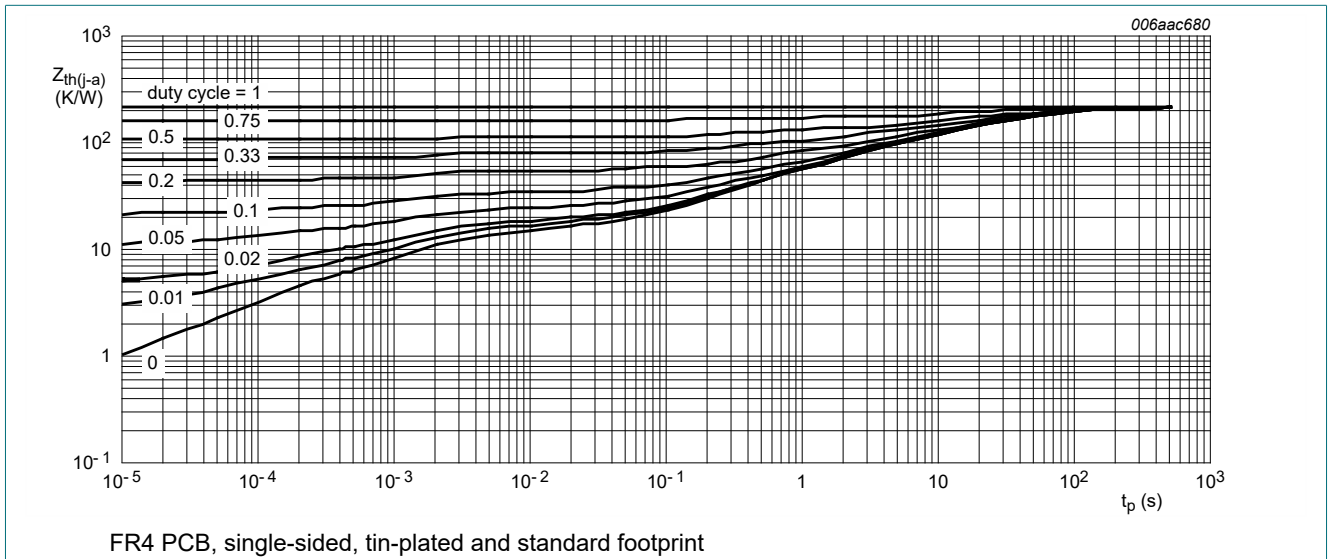


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

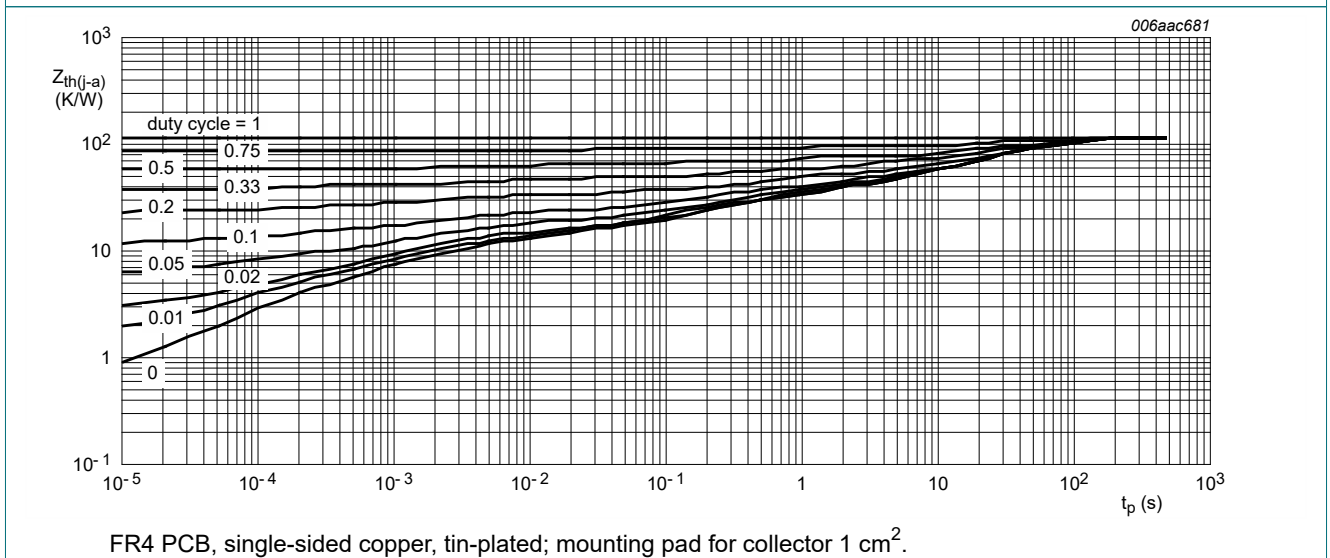
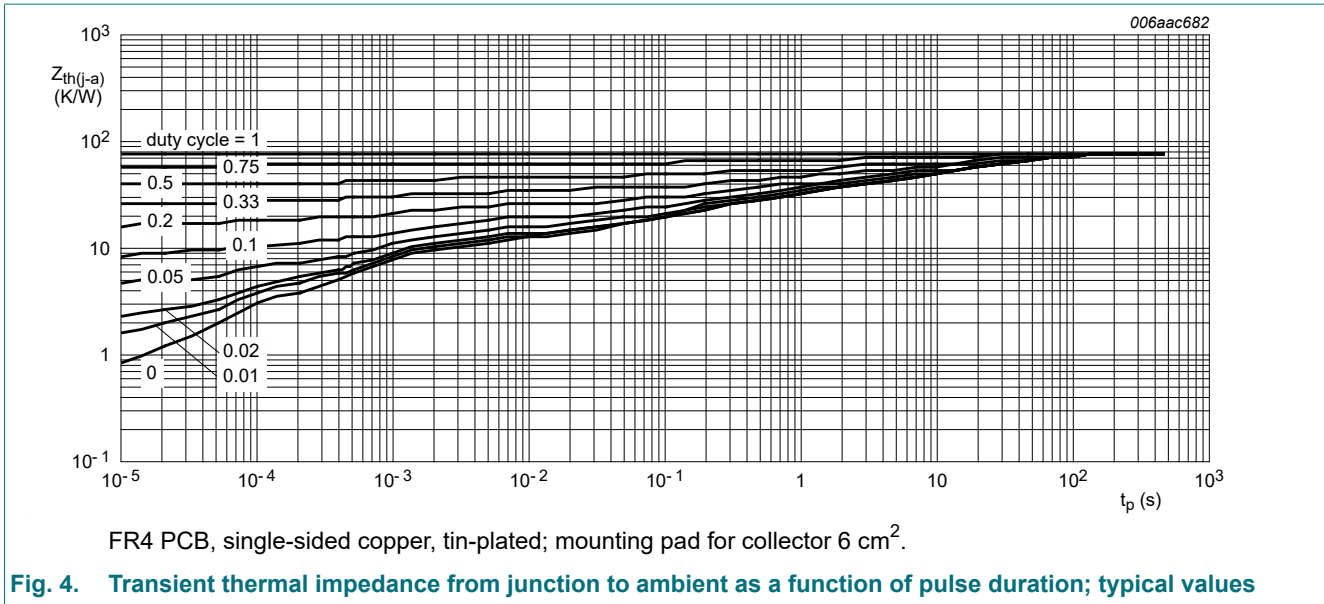


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 8. Characteristics

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|---------------|--------------------------------------|---|-----|-----|-----|---------------|--|
| $V_{(BR)CBO}$ | collector-base breakdown voltage | $I_C = 100 \mu\text{A}; I_E = 0; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | 60 | - | - | V | |
| $V_{(BR)CEO}$ | collector-emitter breakdown voltage | $I_C = 2 \mu\text{A}; I_B = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | 60 | - | - | V | |
| $V_{(BR)EBO}$ | emitter-base breakdown voltage | $I_C = 0 \text{ A}; I_E = 100 \mu\text{A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | 5 | - | - | V | |
| I_{CBO} | collector-base cut-off current | $V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | - | - | 100 | nA | |
| | | $V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}; T_j = 150 \text{ }^\circ\text{C}$ | - | - | 10 | μA | |
| I_{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | - | - | 100 | nA | |
| h_{FE} | DC current gain | | | | | | |
| | BCX55-Q | $V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 63 | - | - | |
| | | $V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 63 | - | 250 | |
| | | $V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 40 | - | - | |
| | BCX55-10-Q | $V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 63 | - | - | |
| | | $V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 63 | - | 160 | |
| | | $V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 40 | - | - | |
| | BCX55-16-Q | $V_{CE} = 2 \text{ V}; I_C = 5 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 63 | - | - | |
| | | $V_{CE} = 2 \text{ V}; I_C = 150 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 100 | - | 250 | |
| | | $V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | 40 | - | - | |
| V_{CEsat} | collector-emitter saturation voltage | $I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | - | - | 0.5 V | |
| V_{BE} | base-emitter voltage | $V_{CE} = 2 \text{ V}; I_C = 500 \text{ mA}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | [1] | - | - | 1 V | |
| C_c | collector capacitance | $V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | - | 6 | - | pF | |
| f_T | transition frequency | $V_{CE} = 5 \text{ V}; I_C = 50 \text{ mA}; f = 100 \text{ MHz}; T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ | 100 | 180 | - | MHz | |

[1] pulsed; $t_p \leq 300 \mu\text{s}$; $\delta \leq 0.02$

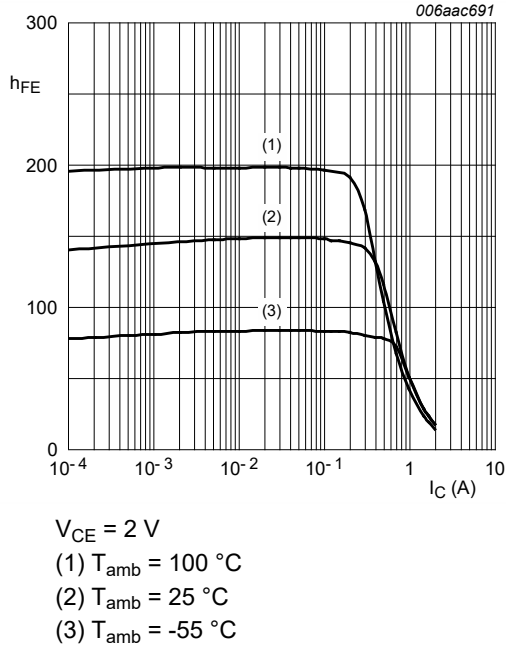


Fig. 5. DC current gain as a function of collector current; typical values

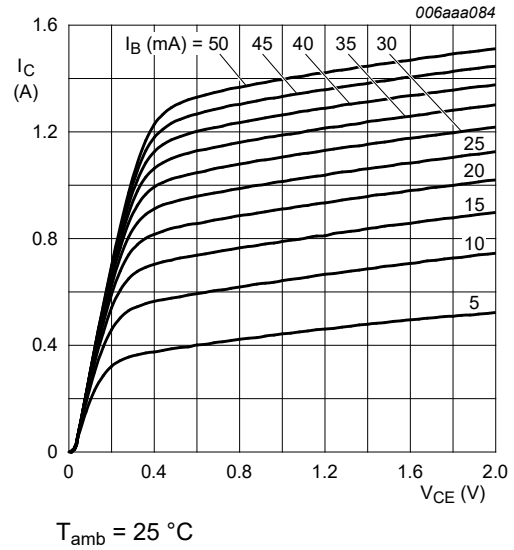


Fig. 6. Collector current as a function of collector-emitter voltage; typical values

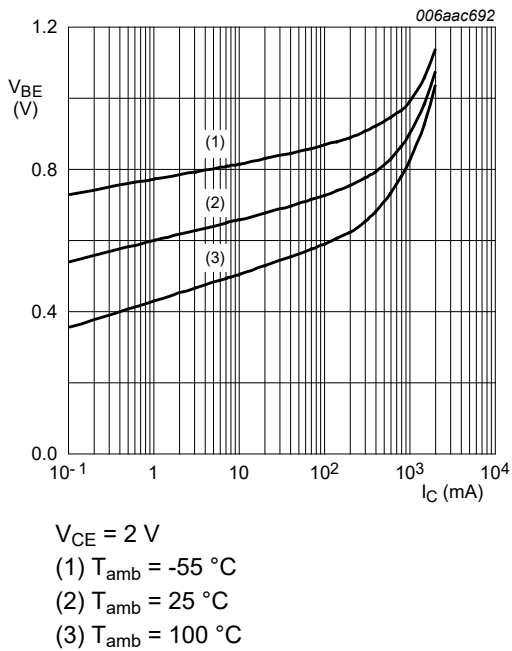


Fig. 7. Base-emitter voltage as a function of collector current; typical values

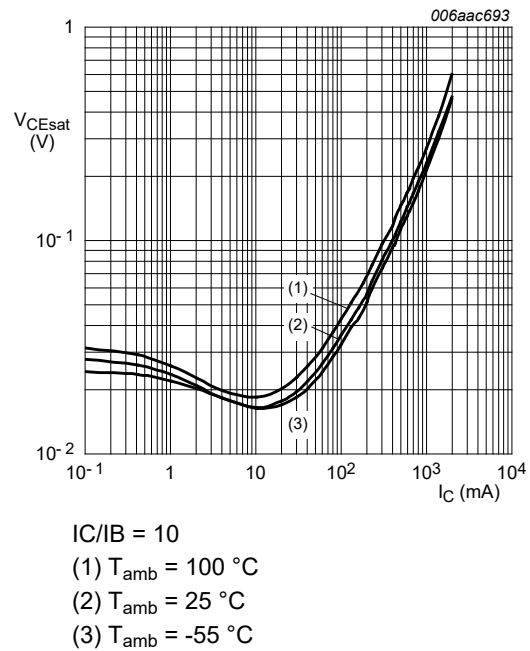


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

11. Test information

11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101 - Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

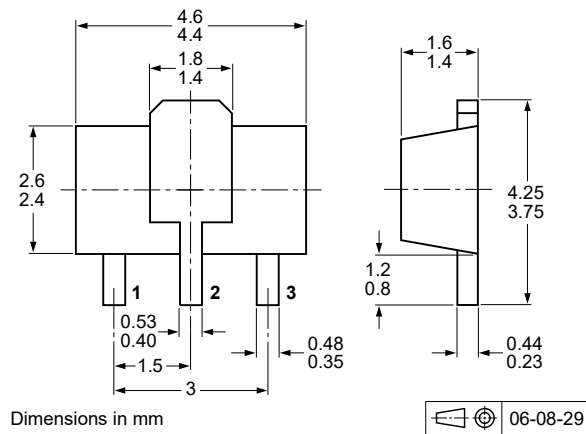


Fig. 9. Package outline SOT89 (SC-62)

13. Soldering

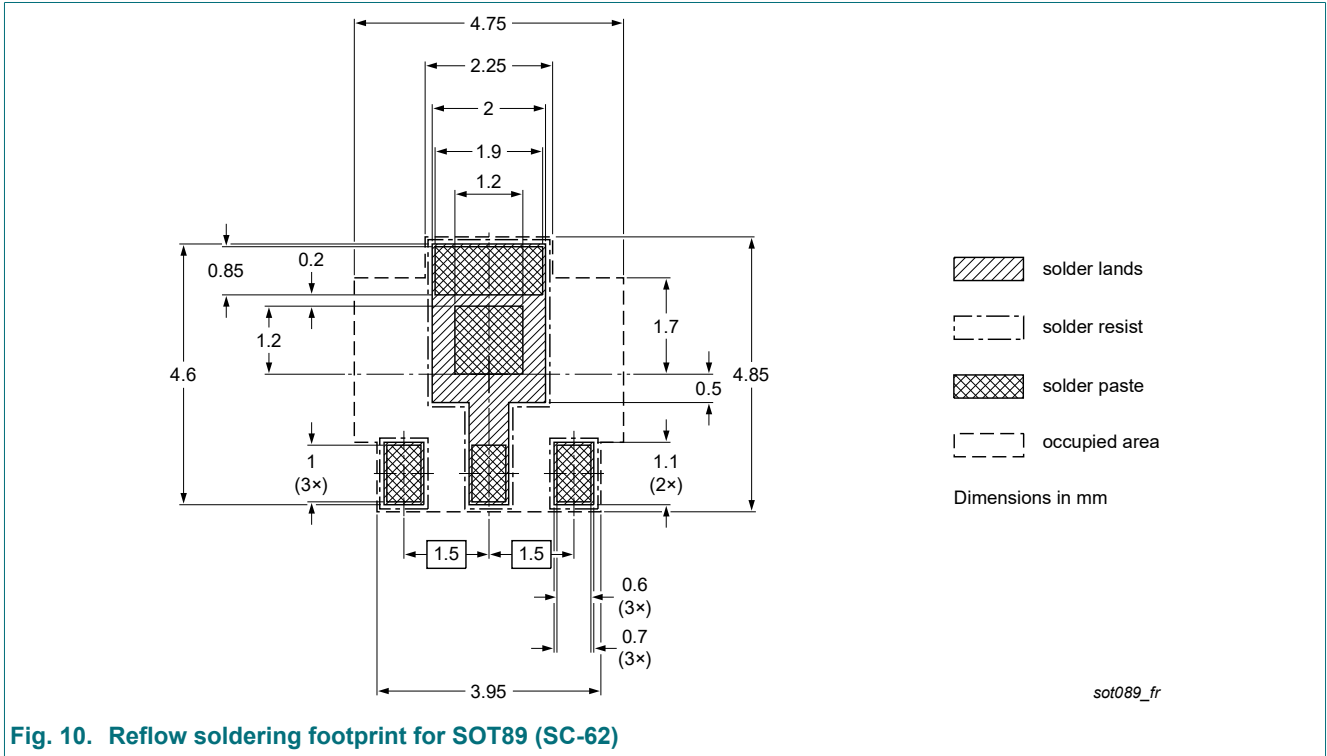


Fig. 10. Reflow soldering footprint for SOT89 (SC-62)

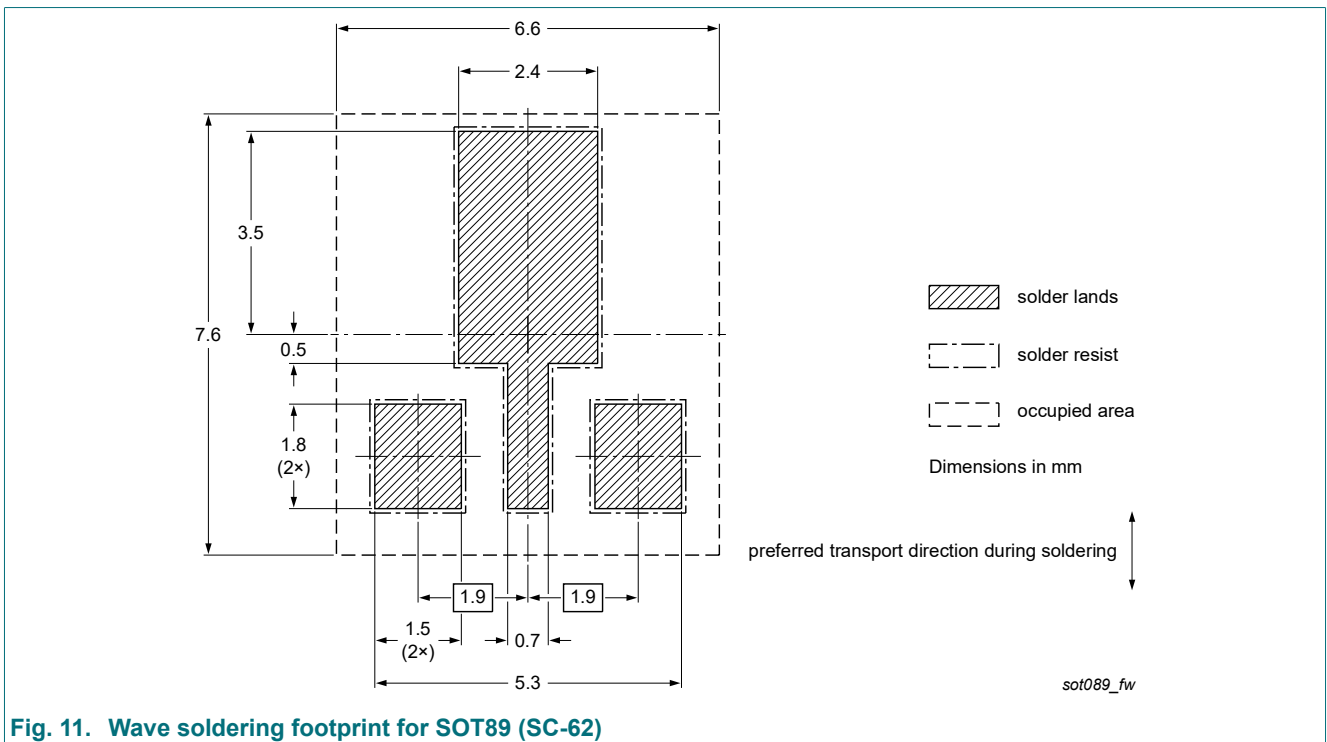


Fig. 11. Wave soldering footprint for SOT89 (SC-62)

14. Revision history

Table 9. Revision history

| Data sheet ID | Release date | Data sheet status | Change notice | Supersedes |
|-----------------|--------------|--------------------|---------------|------------|
| BCX55-Q_SER v.1 | 20220714 | Product data sheet | - | - |

15. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions".
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Date of release: 14 July 2022

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